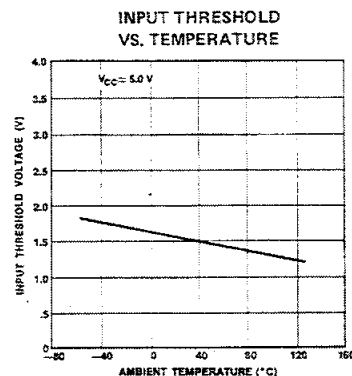
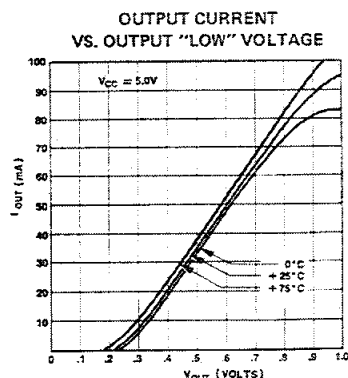
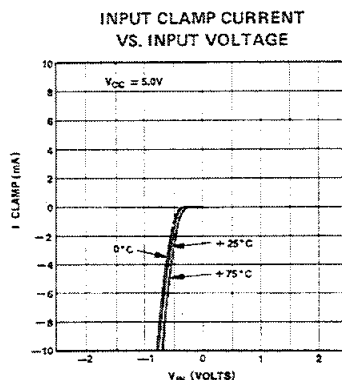
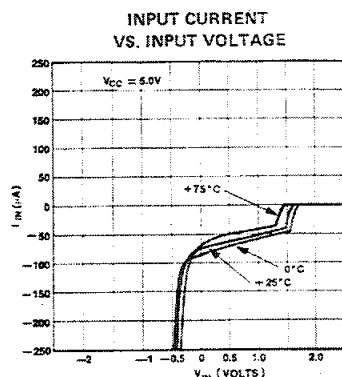
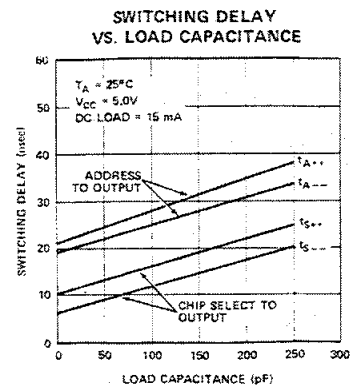
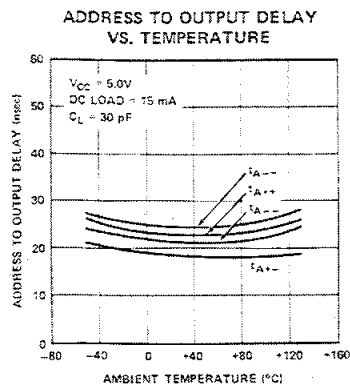
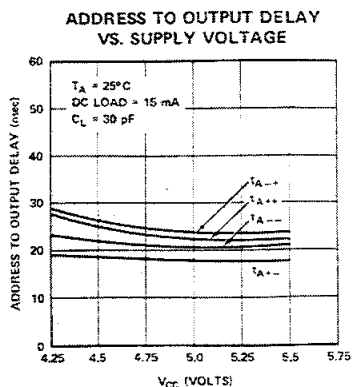
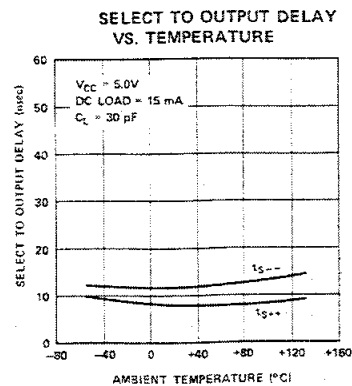
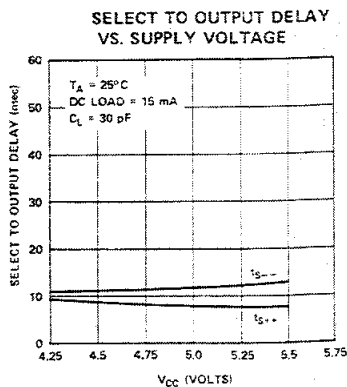


Typical D. C. Characteristics



Typical A. C. Characteristics



Switching Characteristics

A. C. Characteristics $V_{CC} = +5V \pm 5\%$, $T_A = 0^\circ C$ to $+75^\circ C$

SYMBOL	PARAMETER	LIMIT		UNIT	CONDITIONS
		TYP. (1)	MAX.		
t_{A++}, t_{A--} t_{A+-}, t_{A-+}	Address to Output Delay	25	45	ns	Both C.S. lines must be at ground potential to activate the ROM.
t_{S++}, t_{S--}	Chip Select to Output Delay	13	20	ns	

NOTE 1: Typical values are at $25^\circ C$ and at nominal voltage.Capacitance ⁽²⁾ $T_A = 25^\circ C$

SYMBOL	PARAMETER	LIMIT				UNIT	TEST CONDITIONS
		PLASTIC		CERAMIC			
		TYP.	MAX.	TYP.	MAX.		
C _{INA}	Address Input Capacitance	5	8	6	10	pF	V _{CC} = 5V V _{INA} = 2.5V
C _{INS}	Chip Select Input Capacitance	5	8	5	10	pF	V _{CC} = 5V V _{INS} = 2.5V
C _{OUT}	Output Capacitance	7	10	8	12	pF	V _{CC} = 5V V _{OUT} = 2.5V

NOTE 2: This parameter is only periodically sampled and is not 100% tested.

Conditions of Test:

Input pulse amplitudes - 2.5V

Input pulse rise and fall times of

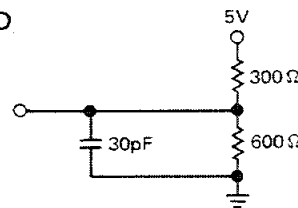
5 nanoseconds between 1 volt and 2 volts

Speed measurements are made at 1.5 volt levels

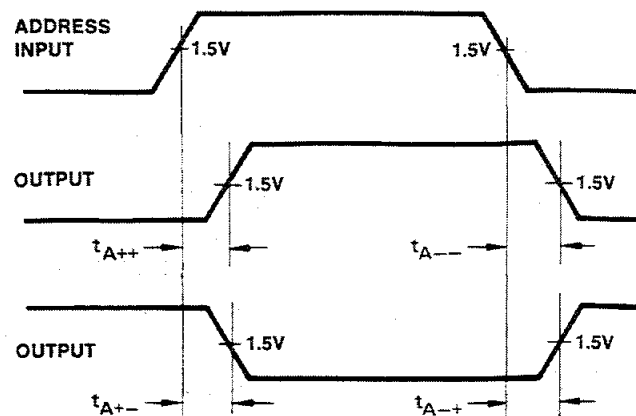
Output loading is 15 mA and 30 pF

Frequency of test - 2.5 MHz

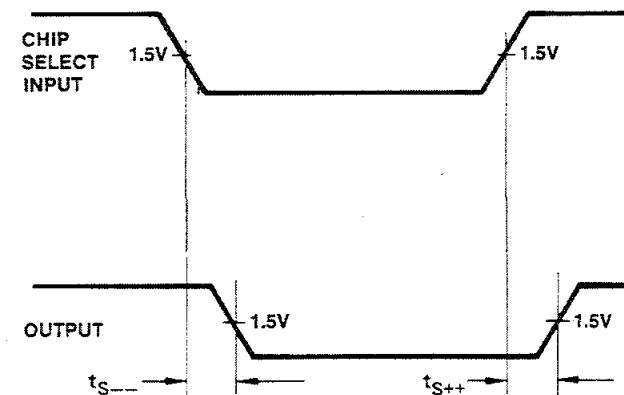
15 mA TEST LOAD



ADDRESS TO OUTPUT DELAY



CHIP SELECT TO OUTPUT DELAY



Absolute Maximum Ratings*

Temperature Under Bias	−65° to +125°C
Storage Temperature	−65° to +160°C
All Input, Output or Supply Voltages	−0.5V to 7 Volts
All Input Voltages	−1.0 to 5.5V
Output Currents	100 mA

***COMMENT**

Stresses above those listed under "Absolute Maximum Rating" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or at any other condition above those indicated in the operational sections of this specification is not implied.

D. C. Characteristics: All Limits Apply for $V_{CC} = +5.0V \pm 5\%$, $T_A = 0^\circ C$ to $+75^\circ C$

SYMBOL	PARAMETER	LIMITS			UNIT	TEST CONDITIONS
		MIN.	TYP. ⁽¹⁾	MAX.		
I_{FA}	ADDRESS INPUT LOAD CURRENT			−0.25	mA	$V_{CC} = 5.25V$, $V_A = 0.45V$
I_{FS}	CHIP SELECT INPUT LOAD CURRENT			−0.25	mA	$V_{CC} = 5.25V$, $V_S = 0.45V$
I_{RA}	ADDRESS INPUT LEAKAGE CURRENT			40	μA	$V_{CC} = 5.25V$, $V_A = 5.25V$
I_{RS}	CHIP SELECT INPUT LEAKAGE CURRENT			40	μA	$V_{CC} = 5.25V$, $V_S = 5.25V$
V_{CA}	ADDRESS INPUT CLAMP VOLTAGE			−1.0	V	$V_{CC} = 4.75V$, $I_A = -5.0mA$
V_{CS}	CHIP SELECT INPUT CLAMP VOLTAGE			−1.0	V	$V_{CC} = 4.75V$, $I_S = -5.0mA$
V_{OL}	OUTPUT LOW VOLTAGE			0.45	V	$V_{CC} = 4.75V$, $I_{OL} = 15mA$
I_{CEX}	OUTPUT LEAKAGE CURRENT			100	μA	$V_{CC} = 5.25V$, $V_{CE} = 5.25V$
I_{CC}	POWER SUPPLY CURRENT		90	125	mA	$V_{CC} = 5.25V$, $V_{A0} \rightarrow V_{A7} = 0V$, $V_{S0} = V_{S1} = 0V$
V_{IL}	INPUT "LOW" VOLTAGE			0.85	V	$V_{CC} = 5.0V$
V_{IH}	INPUT "HIGH" VOLTAGE	2.0			V	$V_{CC} = 5.0V$

Note 1: Typical values are at 25°C and at nominal voltage.

HIGH SPEED FULLY DECODED 1024 BIT READ ONLY MEMORY

- Fast Access Time--45 nsec
Maximum over Temperature
and Supply Voltage Variation.
- Low Power Dissipation --
0.5 mW/bit typical.
- DTL and TTL Compatible--Input
Loading is .25 mA max. --
Outputs sink 15 mA.
- OR-Tie Capability--Open
Collector Outputs
- Simple Memory Expansion --
2 Chip Select Input Leads.
- Fully Decoded --on Chip Address
Decode and Buffer.
- Minimum Line Reflection -- Low
Voltage Diode Input Clamp.
- Standard Packaging -- 16 Pin Dual
In-Line Lead Configuration.

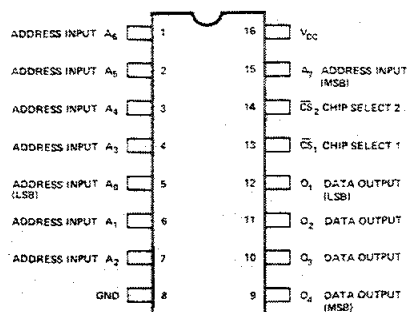
The 3301A is a fully decoded 1024 bit read only memory organized as 256 words by 4 bits. It is a higher speed version of the 3301 and is a direct pin for pin replacement of the 3301. Its performance is specified over the complete ambient temperature range of 0°C to 75°C and a V_{CC} supply voltage range of $5V \pm 5\%$. The 3301A is programmed at the final step of processing which allows fast turnaround.

The OR tie capability and the 2 chip select inputs of the 3301A allow easy memory expansion into larger word and bit lengths.

The 3301A is mask programmed to customized patterns. It is also available in standard "off the shelf" configurations. Ideal applications are in microprogramming and table look up.

The 3301A is manufactured using Schottky barrier diode clamped transistors which allows higher switching speeds than those devices made with conventional gold diffusion process.

PIN CONFIGURATION



PIN NAMES

A_0-A_7	ADDRESS INPUTS
CS_1-CS_2	CHIP SELECT INPUTS
O_1-O_4	DATA OUTPUTS

LOGIC SYMBOL

